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RECORDATION FORM COVER SHEET

Docket: 0819-272

10 the Ho	onorable Assistant Commissioner for Patent. Please record the attached original documents or copy thereof.								
1.	Name of conveying parties: Toshitaka HIBI, Kazuo HAYAMA								
Additiona	I name(s) of conveying party(ies) attached? [] Yes [X] No 8-26-49								
2.	Name and address of receiving party:								
	atsushita Electronics Corporation Idress: 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan								
	State ZIP								
	I name(s) & addresses(es) attached? []Yes [X] No								
3.	Name of Conveyance:								
	[X] Assignment [] Merger								
	[] Security Agreement []Change of Name [] Other								
	Execution Date: August 18, 1999								
4.	Application number(s) or patent number(s):								
	If this document is being filed together with a new application, the execution date of the application is: August 18, 1999								
	Title: METHOD FOR FABRICATING SEMICONDUCTOR DEVICE								
	A: Patent Application No.(s) Additional numbers attached? Yes No								
	Additional hambors attached: 100								
5.	Name and address of party to whom correspondence concerning document should be mailed:								
	Name: SIXBEY, FRIEDMAN, LEEDOM & FERGUSON, P.C.								
	Street Address: 8180 Greensboro Drive, Suite 800								
	City: McLean State: Virginia ZIP 22102								
6.	Total number of applications and patents involved: 1								
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7. 02 FC:5	Total fee (37 CFR 3.41):\$40.00 }								
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Attorney Docket No. 0819-272

ASSIGNMENT

WHEREAS, <u>Toshitaka HIBI, Kazuo HAYAMA</u> (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in <u>METHOD FOR FABRICATING SEMICONDUCTOR DEVICE</u> for which an application for Letters Patent of the United States of America has been executed by the undersigned on <u>August 18, 1999</u>, and;

WHEREAS, Matsushita Electronics Corporation of 1-1, Saiwai-cho, Takatsuki-shi, Osaka 569-1193, Japan its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America and its territories and for all foreign countries, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America and its territories, dependencies and possessions, and in and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or any continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims under or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

PATENT REEL: 010210 FRAME: 0614 The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby convenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Sixbey, Friedman, Leedom & Ferguson, P.C. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date A	ug.	18,	1.9 9	_, Name of Inventor	Toshi taka Toshitaka HI	HIBI BI	(SEAL)
Date A	ug.	18,	! 99	_, Name of Inventor	Kazuo HAYA		(SEAL)
Date				_, Name of Inventor			(SEAL)
Date				_, Name of Inventor	·		(SEAL)
Date				_, Name of Inventor	· <u> </u>		(SEAL)
or Nota	ry Pu	blic.	If not	hould preferably be , then the execution who should sign her	n by the Inventor(
Witness	Kaz	uya (nam	KIKUC e)	<u> </u>	Kanuya (signature)	Kikuchi	
Witness	Ken	ji K	AWAKI	TA	(signature)	makita	